



Irradiation studies of the ATLAS Pixel Electronics.

Aldo F. Saavedra

For the ATLAS Pixel Detector Community

AFSaavedra@lbl.gov

Lawrence Berkeley National Laboratory, CA, USA





The talk will focus on two studies performed on the electronics of the pixel detector:

- The irradiation of bare FE-1Is conducted in March 2002.
- The irradiation of single pixel chip assemblies conducted at the begining of May 2002.





The irradiation of the bare FE-1I chips was performed at the 88" cyclotron located at LBL. The aim was to:

- Study the performance of the chip as a function of dose under realistic LHC operating conditions.
- To evaluate the radiation tolerance of the chip.





To achieve this:

- Two bare chips, FE-1A (210) and FE-1B (128) were irradiated upto a dose of \approx 50Mrads.
- Throughout the whole irradiation the bare chips were kept at a temperature 7C and powered.
- The program followed was loosely based on the ATLAS procedure to evaluate radiation tolerance of electronics.





The ATLAS procedure to evaluate the radiation tolerance of CMOS electronics is composed of the following steps:

- Eleven Devices will be tested
- Electrical Measurements Performed
- Irradiation upto RTC (Radiation Tolerance Criteria)
- Annealing for 168 hours at 20C with electrical measurements at the 24th and 168th hour mark.
- Low Radiation Dose Rate Simulation: 168 hours at 100C
- Electrical Measurements























Bump bonded single pixel chip assemblies were irradiated at the Proton Synchroton at CERN to:

- To simulate the operation of the pixel detector in the harsh radiation environment that will be present during the operation of the LHC.
- To understand any degradation in the performance with respect to radiation dose.
- To evaluate the different types of chips(FEI-1A/FEI-1B), bump vendors(AMS/IZM) and sensor vendors(CIS/TesIa) available to the ATLAS pixel community.





To achieve this:

- Eight bump bonded assemblies were irradiated to study every possible combination.
- The average dose recieved by each assembly was 2.2×10^{15} protons/cm² $\approx 1.1 \times 10^{15}$ 1MeV neutron equivalent dose.
- All assemblies were kept at -10C and were powered throughout the irradiation period.





- Threshold scans, TOT calibrations, leakage currents scans and SEU measurements were conducted periodically during the irradiation.
- Post irradiation measurements were also conducted after the assemblies were annealed to simulate the expected temperature history of the pixel detector during 10 years of operation in the ATLAS detector.

Results to be presented today will only include the post irradiation measurements for a single chip assembly with the following characteristics \rightarrow FE-1B/IZM/CIS.





The post irradiation measurements included the following:

- Threshold Scans: Performed to measure the threshold and the noise of each pixel composing the assembly under different conditions.
- Leakage Current Scans: Performed to measure the leakage current of each pixel composing the assembly under different conditions.





- Cross Talk Scans: Performed to measure the cross talk between pixels. The number of hits registered by a pixel is measured when its adjacent neighbours are injected with a large amount of charge (150Ke per pair).
- Time Walk Performed to study the pulse height slewing of the front-end and timestamping circuitry in FE-I1.



rrrrr

BERKELEY LAB





Aldo F. Saavedra - Pixel 2002, September 2002 - p.14/26









Post Irradiation Results:Noise





Aldo F. Saavedra - Pixel 2002, September 2002 - p.16/26







Aldo F. Saavedra - Pixel 2002, September 2002 - p.17/26

Post Irradiation Results:Leakage Curren



Post Irradiation Leakage Current at -7C (FEI-1B/IZM/CIS)

rrrrrr

BERKELEY LAP



Aldo F. Saavedra - Pixel 2002, September 2002 - p.18/26





Pixel Current Vs Noise Pixel Current (nA) 60 00 normal pixels long pixels ganged pixels long ganged pixels 40 30 20 300 800 900 1000 200 100 400 500 600 700 Noise (e)







Post Irradiation Results:TOT dispersion

rrrrrr

BERKELEY LAB

m





Post Irradiation Results: Timewalk











Post Irradiation Results:Cross Talk





Aldo F. Saavedra - Pixel 2002, September 2002 - p.24/26











- All the single pixel chip assemblies operated properly during the irradiation.
- The post irradiation measurements show that the chip meets all of our requirements but there are areas that need improving.
- The current threshold tunning is marginally adequate at the moment but it will be improved in the next generation.
- The current timewalk of 2000e is barely acceptable. For example setting a threshold of 3Ke means that all the charges above 5Ke will be within 20ns. We are aiming for a timewalk of 1000e.